UMF7N

Transistors

Power management (dual transistors) **UMF7N**

2SC5585 and DTC123EE are housed independently in a UMT package.

Application

Power management circuit

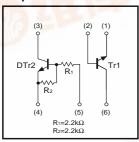
Features

- 1) Power switching circuit in a single package.
- 2) Mounting cost and area can be cut in half.

Structure

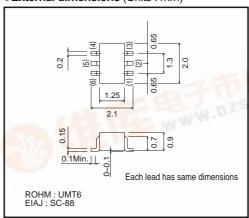
Silicon epitaxial planar transistor

Equivalent circuits



Packaging specific	ations	
Туре	UMF7N	
Package	UMT6	•
Marking	F7	-
Code	TR	-
Basic ordering unit(pieces)	3000	=

●External dimensions (Units : mm)





●Absolute maximum ratings (Ta=25°C)

Tr1

Parameter	Symbol	Limits	Unit
Collector-base voltage	Vсво	15	V
Collector-emitter voltage	Vceo	12	V
Emitter-base voltage	Vево	6	V
Callagtor augrent	Ic	500	mA
Collector current	Іср	1.0	A *1
Power dissipation	Pc	150(TOTAL)	mW *2
Junction temperature	Tj	150	°C
Range of storage temperature	Tstg	-55~+150	°C

DTr2

Parameter	Symbol	Limits	Unit
Supply voltage	Vcc	50	V
Input voltage	Vin	-10 ~ +20	V
Collector current	Ic	100	mA *1
Output current	lo	100	mA
Power dissipation	Pc	150(TOTAL)	mW *2
Junction temperature	Tj	150	°C
Range of storage temperature	Tstg	<i>–</i> 55∼+150	°C

●Electrical characteristics (Ta=25°C)

Tr1

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-emitter breakdown voltage	BVceo	12	_	_	V	Ic=1mA
Collector-base breakdown voltage	ВУсво	15	_	_	V	Ic=10μA
Emitter-base breakdown voltage	ВVево	6	_	_	V	Iε=10μA
Collector cut-off current	Ісво	_	_	100	nA	VcB=15V
Emitter cut-off current	ІЕВО	_	_	100	nA	V _{EB} =6V
Collector-emitter saturation voltage	VCE(sat)	_	90	250	mV	Ic=200mA, IB=10mA
DC current gain	hfe	270	_	680	_	Vce=2V, Ic=10mA
Transition frequency	f⊤	_	320	_	MHz	Vce=2V, Ie=-10mA, f=100MHz
Collector output capacitance	Cob	_	7.5	_	pF	Vcb=10V, Ie=0mA, f=1MHz

DTr2

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Input voltage	VI(off)	_	_	0.5	V	Vcc=5V, Io=100μA
	VI(on)	3.0	_	_	V	Vo=0.3V, Io=20mA
Output voltage	Vo(on)	_	100	300	mV	Vo=10mA, I⊫0.5mA
Input current	lı	_	_	3.8	mA	Vi=5V
Output current	IO(off)	_	_	0.5	μΑ	Vcc=50V, Vi=0V
DC current gain	Gı	20	_	_	_	Vo=5V, Io=20mA
Transition frequency	f⊤	_	250	_	MHz	Vc=10V, I=-5mA, f=100MHz *
Input resistance	R ₁	_	2.2	_	kΩ	_
Resistance ratio	R2/R1	0.8	1.0	1.2	_	_

^{*} Characteristics of built-in transistor.

^{*1} Single pulse Pw=1ms
*2 120mW per element must not be exceeded.
Each terminal mounted on a recommended land.

^{*1} Characteristics of built-in transistor.
*2 120mW per element must not be exceeded.
Each terminal mounted on a recommended land.

•Electrical characteristic curves

Tr1

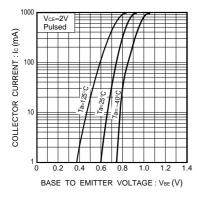


Fig.1 Grounded emitter propagation characteristics

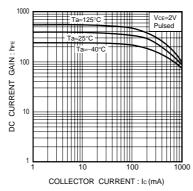


Fig.2 DC current gain vs. collector current

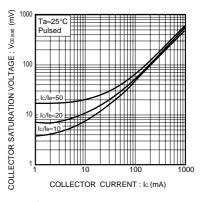


Fig.3 Collector-emitter saturation voltage vs. collector current (\boldsymbol{I})

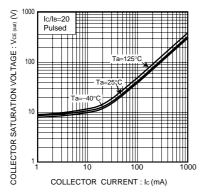


Fig.4 Collector-emitter saturation voltage vs. collector current (II)

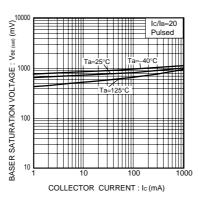


Fig.5 Base-emitter saturation voltage vs. collector current

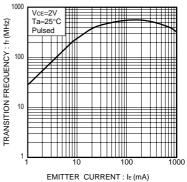


Fig.6 Gain bandwidth product vs. emitter current

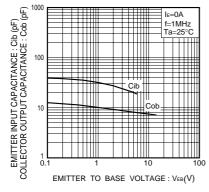


Fig.7 Collector output capacitance vs. collector-base voltage Emitter input capacitance vs. emitter-base voltage

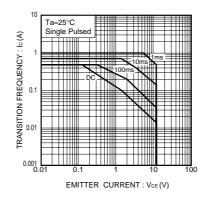


Fig.8 Safe operation area

Fig.9 Input voltage vs. output current (ON characteristics)

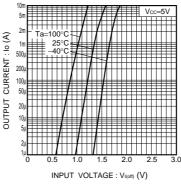


Fig.10 Output current vs. input voltage (OFF characteristics)

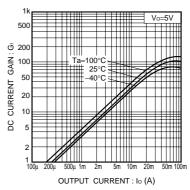


Fig.11 DC current gain vs. output current

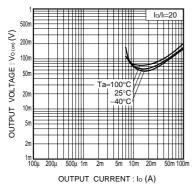


Fig.12 Output voltage vs. output current

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